



HEF4528(LX)

Dual Monostable Multivibrator

Product Specification

Specification Revision History:

Version	Date	Description
2022-06-A1	2022-06	New
2023-04-B1	2023-04	Update the template



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1、General Description

The HEF4528 is a dual retriggerable-resettable monostable multivibrator. Each multivibrator has an active LOW input ($\bar{n}A$), and active HIGH input (nB), an active LOW clear direct input ($\bar{n}CD$), an output (nQ) and its complement ($\bar{n}Q$), and two external timing component connecting pins ($nCEXT$, always connected to ground, and $nREXT/CEXT$).

An external timing capacitor (C_{EXT}) must be connected between $nCEXT$ and $nREXT/CEXT$ and an external resistor (R_{EXT}) must be connected between $nREXT/CEXT$ and V_{DD} . The output pulse duration is determined by the external timing components C_{EXT} and R_{EXT} . A HIGH-to-LOW transition on $\bar{n}A$ when nB is LOW or a LOW-to-HIGH transition on nB when $\bar{n}A$ is HIGH produces a positive pulse (LOW-HIGH-LOW) on nQ and a negative pulse (HIGH-LOW-HIGH) on $\bar{n}Q$ if the $\bar{n}CD$ is HIGH. A LOW on $\bar{n}CD$ forces nQ LOW, $\bar{n}Q$ HIGH and inhibits any further pulses until $\bar{n}CD$ is HIGH. It operates over a recommended V_{DD} power supply range of 3V to 12V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD} , V_{SS} , or another input.

Features:

- Wide supply voltage range from 3V to 12V
- Fully static operation
- 5V and 10V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40°C to +125°C
- Packaging information: SOP16



Ordering Information:

Reel packing specifications:

Part number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Notes
HEF4528BT(LX)	SOP16	HEF4528BT	4000 PCS/reel	8000 PCS/box	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing:1.27mm

Note: If the physical information is inconsistent with the ordering information, please refer to the actual product.

2、Block Diagram And Pin Description

2.1、Block Diagram

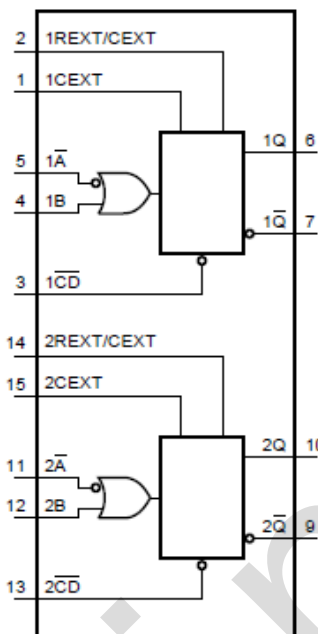


Figure 1. Functional diagram

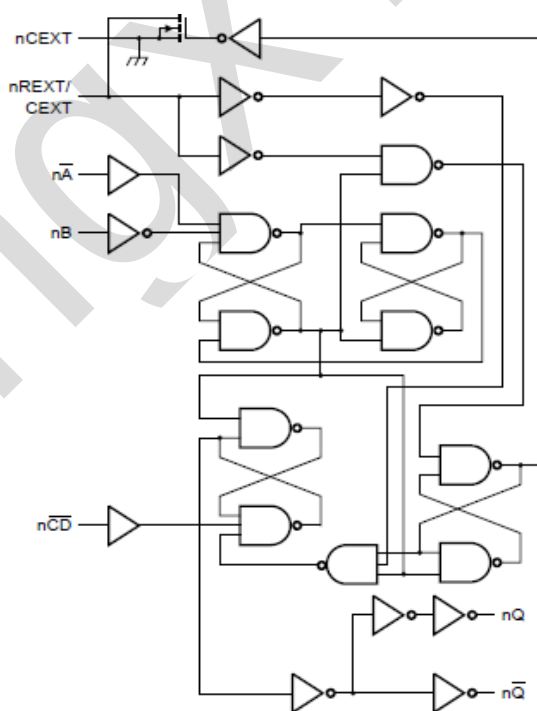
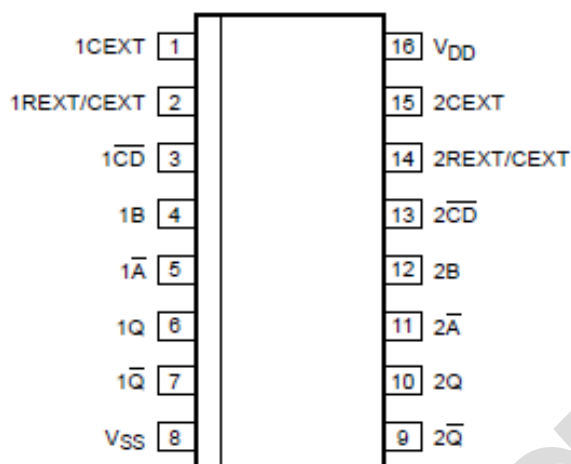


Figure 2. Logic diagram for one monostable multivibrator



2.2、Pin Configurations



2.3、Pin Description

Pin No.	Pin Name	Description
1	1CEXT	external capacitor connection (always connected to ground)
2	1REXT/ CEXT	external capacitor/resistor connection
3	1CD	clear direct input (active LOW)
4	1B	input (LOW-to-HIGH triggered)
5	1A	input (HIGH-to-LOW triggered)
6	1Q	output
7	1Q	complementary output (active LOW)
8	V _{SS}	ground (0V)
9	2Q	complementary output (active LOW)
10	2Q	output
11	2A	input (HIGH-to-LOW triggered)
12	2B	input (LOW-to-HIGH triggered)
13	2CD	clear direct input (active LOW)
14	2REXT/ CEXT	external capacitor/resistor connection
15	2CEXT	external capacitor connection (always connected to ground)
16	V _{DD}	supply voltage



2.4、Function Table

Input			Output	
$\bar{n}A$	nB	$n\bar{C}D$	nQ	$n\bar{Q}$
↓	L	H		
H	↑	H		
X	X	L	L	H

Note:

[1] H=HIGH voltage level; L=LOW voltage level; X=don't care;

[2] ↑=positive-going clock transition; ↓=negative-going transition;

[3]  =one HIGH level output pulse, with the pulse width determined by C_{EXT} and R_{EXT} ;

[4]  =one LOW level output pulse, with the pulse width determined by C_{EXT} and R_{EXT} .

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(Voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Max.	Unit
supply voltage	V_{DD}	-		-0.5	+14	V
DC input current	I_{IK}	any one input		-	±10	mA
input voltage	V_I	all inputs		-0.5	$V_{DD}+0.5$	V
storage temperature	T_{stg}	-		-65	+150	°C
total power dissipation	P_{tot}	-		-	500	mW
device dissipation	P	per output transistor		-	100	mW
Soldering temperature	T_L	10s	SOP	260		°C

3.2、Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	V_{DD}	-	3	-	12	V
ambient temperature	T_{amb}	in free air	-40	-	+125	°C



3.3、Electrical Characteristics

3.3.1、DC Characteristics 1

($T_{amb}=25^{\circ}\text{C}$, voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions			$T_{amb}=25^{\circ}\text{C}$			Unit
		$ I_O (\mu\text{A})$	$V_O(\text{V})$	$V_{DD}(\text{V})$	Min.	Typ.	Max.	
supply current	I_{DD}	0	-	5	-	-	20	μA
		0	-	10	-	-	40	μA
LOW-level output current	I_{OL}	-	0.4	5	0.44	-	-	mA
		-	0.5	10	1.1	-	-	mA
HIGH-level output current	I_{OH}	-	2.5	5	-	-	-1.4	mA
		-	4.6	5	-	-	-0.44	mA
		-	9.5	10	-	-	-1.1	mA
LOW-level output voltage	V_{OL}	<1	-	5	-	-	0.05	V
		<1	-	10	-	-	0.05	V
HIGH-level output voltage	V_{OH}	<1	-	5	4.95	-	-	V
		<1	-	10	9.95	-	-	V
LOW-level input voltage	V_{IL}	<1	-	5	-	-	1.5	V
		<1	-	10	-	-	3	V
HIGH-level input voltage	V_{IH}	<1	-	5	3.5	-	-	V
		<1	-	10	7	-	-	V
input leakage current	I_I	-	-	12	-	-	± 1.0	μA

3.3.2、DC Characteristics 2

($T_{amb}=-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions			$T_{amb}=-40^{\circ}\text{C}$		$T_{amb}=+85^{\circ}\text{C}$		$T_{amb}=+125^{\circ}\text{C}$		Unit
		$ I_O (\mu\text{A})$	$V_O(\text{V})$	$V_{DD}(\text{V})$	Min.	Max.	Min.	Max.	Min.	Max.	
supply current	I_{DD}	0	-	5	-	20	-	150	-	150	μA
		0	-	10	-	40	-	300	-	300	μA
LOW-level output current	I_{OL}	-	0.4	5	0.52	-	0.36	-	0.36	-	mA
		-	0.5	10	1.3	-	0.9	-	0.9	-	mA
HIGH-level output current	I_{OH}	-	2.5	5	-	-1.7	-	-1.1	-	-1.1	mA
		-	4.6	5	-	-0.52	-	-0.36	-	-0.36	mA
		-	9.5	10	-	-1.3	-	-0.9	-	-0.9	mA
LOW-level output voltage	V_{OL}	<1	-	5	-	0.05	-	0.05	-	0.05	V
		<1	-	10	-	0.05	-	0.05	-	0.05	V
HIGH-level output voltage	V_{OH}	<1	-	5	4.95	-	4.95	-	4.95	-	V
		<1	-	10	9.95	-	9.95	-	9.95	-	V
LOW-level input voltage	V_{IL}	<1	-	5	-	1.5	-	1.5	-	1.5	V
		<1	-	10	-	3	-	3	-	3	V
HIGH-level input voltage	V_{IH}	<1	-	5	3.5	-	3.5	-	3.5	-	V
		<1	-	10	7	-	7	-	7	-	V
input leakage current	I_I	-	-	12	-	± 1.0	-	± 1.0	-	± 1.0	μA



3.3.3、AC Characteristics

($T_{amb}=25^{\circ}\text{C}$, $V_{SS}=0\text{V}$, unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
HIGH to LOW propagation delay	t_{PHL}	$\overline{nA}$ or $\overline{nB}$ to $\overline{nQ}$; see Figure 5	$V_{DD}=5\text{V}$	-	140	280 ns
			$V_{DD}=10\text{V}$	-	50	100 ns
		$\overline{nCD}$ to $\overline{nQ}$; see Figure 5	$V_{DD}=5\text{V}$	-	105	210 ns
			$V_{DD}=10\text{V}$	-	40	85 ns
LOW to HIGH propagation delay	t_{PLH}	$\overline{nA}$ or $\overline{nB}$ to $\overline{nQ}$; see Figure 5	$V_{DD}=5\text{V}$	-	155	305 ns
			$V_{DD}=10\text{V}$	-	60	115 ns
		$\overline{nCD}$ to $\overline{nQ}$; see Figure 5	$V_{DD}=5\text{V}$	-	120	240 ns
			$V_{DD}=10\text{V}$	-	50	105 ns
transition time	t_t	$\overline{nQ}$, $\overline{nQ}$; see Figure 5	$V_{DD}=5\text{V}$	-	60	120 ns
			$V_{DD}=10\text{V}$	-	30	60 ns
recovery time	t_{rec}	$\overline{nCD}$ to $\overline{nA}$ or $\overline{nB}$; see Figure 6	$V_{DD}=5\text{V}$	0	-75	- ns
			$V_{DD}=10\text{V}$	0	-30	- ns
set-up time	t_{su}	$\overline{nCD}$ to $\overline{nA}$ or $\overline{nB}$; see Figure 6	$V_{DD}=5\text{V}$	0	-105	- ns
			$V_{DD}=10\text{V}$	0	-40	- ns
pulse width	t_w	$\overline{nA}$ LOW; minimum width; see Figure 6	$V_{DD}=5\text{V}$	50	25	- ns
			$V_{DD}=10\text{V}$	30	15	- ns
		$\overline{nB}$ HIGH; minimum width; see Figure 6	$V_{DD}=5\text{V}$	50	25	- ns
			$V_{DD}=10\text{V}$	30	15	- ns
		$\overline{nCD}$ LOW; minimum width; see Figure 6	$V_{DD}=5\text{V}$	60	30	- ns
			$V_{DD}=10\text{V}$	35	15	- ns
		$\overline{nQ}$ or $\overline{nQ}$; $R_{EXT}=5\text{k}\Omega$; $C_{EXT}=15\text{pF}$; see Figure 6	$V_{DD}=5\text{V}$	-	235	- ns
			$V_{DD}=10\text{V}$	-	155	- ns
pulse width variation	Δt_w	$\overline{nQ}$ output variation over temperature range	$V_{DD}=5\text{V}$	-	± 3	- %
			$V_{DD}=10\text{V}$	-	± 2	- %
		$\overline{nQ}$ output variation over voltage range $V_{DD} \pm 5\%$	$V_{DD}=5\text{V}$	-	± 2	- %
			$V_{DD}=10\text{V}$	-	± 1	- %
external timing resistor	R_{EXT}	see Figure 4	$V_{DD}=5\text{V}$	5	-	2 $\text{M}\Omega$
			$V_{DD}=10\text{V}$	5	-	2 $\text{M}\Omega$
external timing capacitor	C_{EXT}	see Figure 4	$V_{DD}=5\text{V}$	no limits		-
			$V_{DD}=10\text{V}$	no limits		-
input capacitance	C_I	-	-	-	7.5	pF

Note:

[1] t_t is the same as t_{TLH} and t_{THL} .

[2] For other R_{EXT} , C_{EXT} combinations and $C_{EXT} < 0.01\mu\text{F}$, see Figure 4.

[3] For other R_{EXT} , C_{EXT} combinations and $C_{EXT} > 0.01\mu\text{F}$, use formula $t_w = K \times R_{EXT} \times C_{EXT}$.

where: t_W = output pulse width (s);

R_{EXT} = external timing resistor (Ω);

C_{EXT} = external timing capacitor (F);

$K=0.42$ for $V_{DD}=5V$;

$K=0.32$ for $V_{DD}=10V$;

$K=0.30$ for $V_{DD}=15V$.

[4] $T_{amb} = -40^\circ C$ to $+85^\circ C$; Δt_W is referenced to t_W at $T_{amb} = 25^\circ C$.

4、Testing Circuit

4.1、AC Testing Circuit

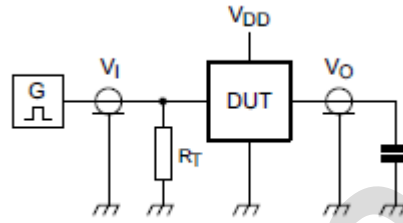


Figure 3. Test circuit for switching times

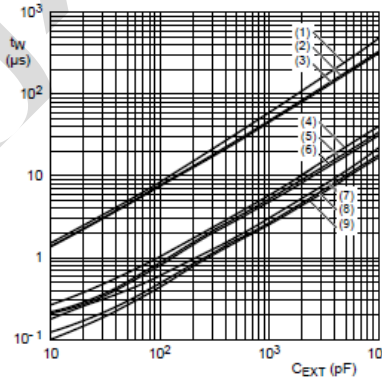
Definitions for test circuit:

DUT = Device Under Test.

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator.

4.2、AC Testing Waveforms



- (1) $R_{EXT} = 100\text{ k}\Omega$, $V_{DD} = 5\text{ V}$.
- (2) $R_{EXT} = 100\text{ k}\Omega$, $V_{DD} = 10\text{ V}$.
- (3) $R_{EXT} = 100\text{ k}\Omega$, $V_{DD} = 15\text{ V}$.
- (4) $R_{EXT} = 10\text{ k}\Omega$, $V_{DD} = 5\text{ V}$.
- (5) $R_{EXT} = 10\text{ k}\Omega$, $V_{DD} = 10\text{ V}$.
- (6) $R_{EXT} = 10\text{ k}\Omega$, $V_{DD} = 15\text{ V}$.
- (7) $R_{EXT} = 5\text{ k}\Omega$, $V_{DD} = 5\text{ V}$.
- (8) $R_{EXT} = 5\text{ k}\Omega$, $V_{DD} = 10\text{ V}$.
- (9) $R_{EXT} = 5\text{ k}\Omega$, $V_{DD} = 15\text{ V}$.

Figure 4. Output pulse width (t_W) as a function of external timing capacitor (C_{EXT})

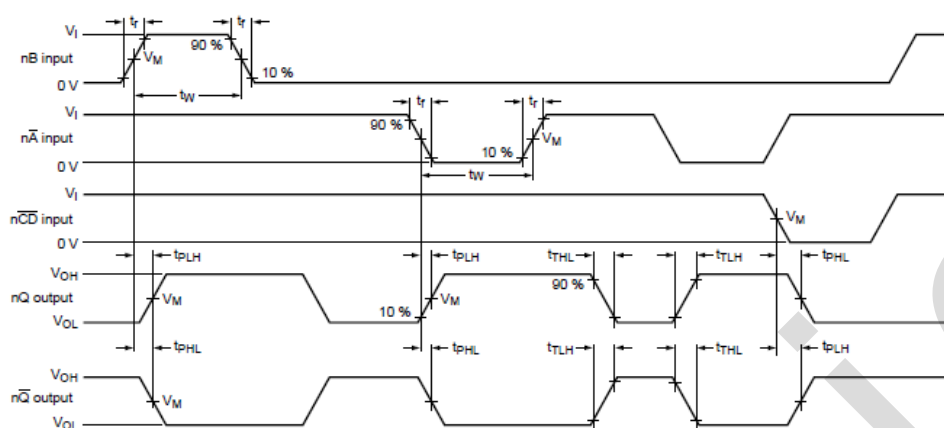


Figure 5. Waveforms showing propagation delays and transition times

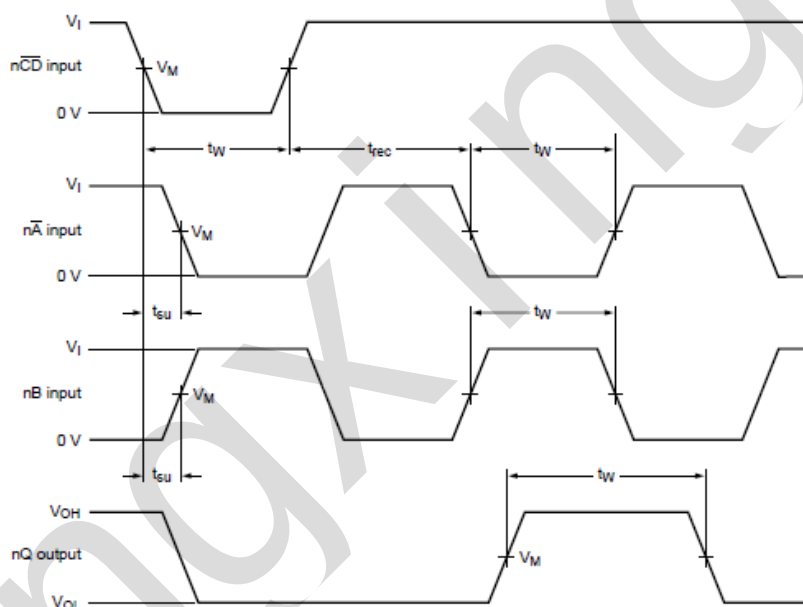


Figure 6. Waveforms showing minimum nA, nB, and nQ pulse widths and set-up and recovery times

4.3、Measurement Points

Supply voltage	Input	Output
V_{DD}	V_M	V_M
5V to 12V	$0.5 \times V_{DD}$	$0.5 \times V_{DD}$

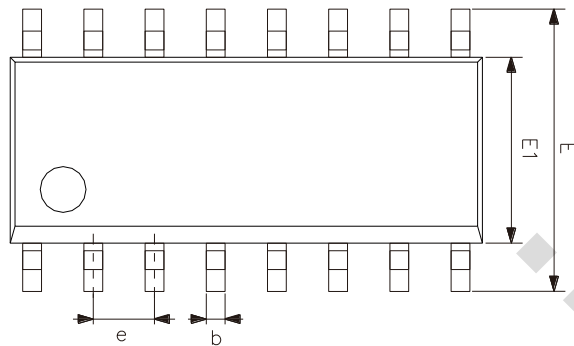
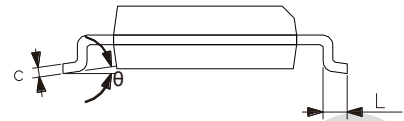
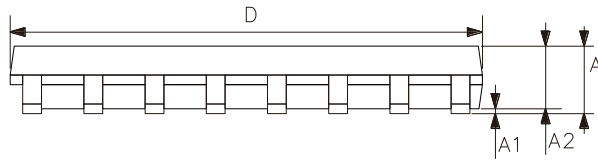
4.4、Test Data

Supply voltage	Input		Load
V_{DD}	V_I	t_r, t_f	C_L
5V to 12V	V_{SS} or V_{DD}	$\leq 20\text{ns}$	50pF



5、Package Information

5.1、SOP16



Symbol	Dimensions (mm)	
	Min.	Max.
A	1.35	1.80
A1	0.10	0.25
A2	1.25	1.55
b	0.33	0.51
c	0.19	0.25
D	9.50	10.10
E	5.80	6.30
E1	3.70	4.10
e	1.27	
L	0.35	0.89
θ	0°	8°



6、Statements And Notes

6.1、The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○: Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×: Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.									